

19-0797; Rev 0; 4/07

**EVALUATION KIT  
AVAILABLE**



# GPS/GNSS Low-Noise Amplifier

**MAX2659**

## General Description

The MAX2659 high-gain, low-noise amplifier (LNA) is designed for GPS, Galileo, and GLONASS applications. Designed in Maxim's advanced SiGe process, the device achieves a 20.5dB gain and an ultra-low-noise figure of 0.8dB while maximizing the input-referred 1dB compression point and the 3rd-order intercept point at -12dBm and -5dBm, respectively.

The MAX2659 operates from a +1.6V to +3.3V single supply and consumes only 4.1mA. The shutdown feature in the device reduces the supply current to be less than 1µA. The MAX2659 is available in a very small, lead-free, RoHS-compliant, 1.5mm x 1.0mm x 0.75mm, 6-pin µDFN package.

## Applications

- Automotive Navigation
- Location-Enabled Mobile Devices
- Telematics (Asset Tracking and Management)
- Personal Navigation Device (PND)
- Cellular Phones with GPS
- Notebook PC/Ultra-Mobile PC
- Recreational, Marine Navigation
- Avionics

## Features

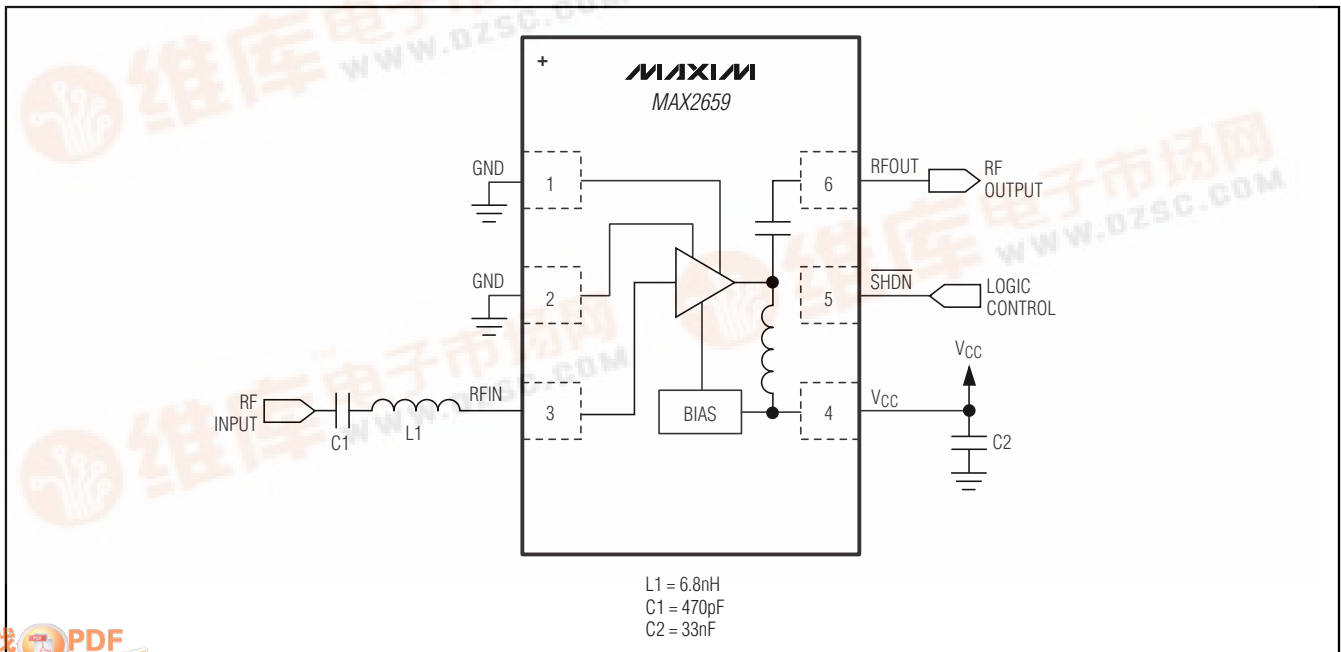
- ◆ **High-Power Gain: 20.5dB**
- ◆ **Ultra-Low-Noise Figure: 0.8dB**
- ◆ **Integrated 50Ω Output Matching Circuit**
- ◆ **Low Supply Current: 4.1mA**
- ◆ **Wide Supply Voltage Range: 1.6V to 3.3V**
- ◆ **Low Bill of Materials**
- ◆ **Small Footprint: 1.5mm x 1.0mm**
- ◆ **Thin Profile: 0.75mm**
- ◆ **Lead-Free and RoHS-Compliant Package**

## Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX2659ELT+	-40°C to +85°C	6 µDFN	L611-2

+Denotes a lead-free package.

## Pin Diagram/Functional Diagram/Typical Application Circuit



# GPS/GNSS Low-Noise Amplifier

## ABSOLUTE MAXIMUM RATINGS

V<sub>CC</sub> to GND .....-0.3V to +4.2V  
 Other Pins to GND.....-0.3V to + Operating V<sub>CC</sub> + 0.3V  
 Maximum RF Input Power .....+10dBm  
 Continuous Power Dissipation (T<sub>A</sub> = +70°C)  
 6-Pin µDFN (derates 2.1mW/°C above +70°C).....167mW

Operating Temperature Range .....-40°C to +85°C  
 Junction Temperature .....+150°C  
 Storage Temperature Range .....-65°C to +160°C  
 Lead Temperature (soldering, 10s) .....+260°C



**CAUTION!** ESD SENSITIVE DEVICE

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

(MAX2659 EV kit; V<sub>CC</sub> = 1.6V to 3.3V, T<sub>A</sub> = -40°C to +85°C, no RF signals are applied. Typical values are at V<sub>CC</sub> = 2.85V and T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage		1.6	2.85	3.3	V
Supply Current	$\overline{\text{SHDN}}$ = high		4.1	5.6	mA
	Shutdown mode, $\overline{\text{SHDN}}$ = low			1	µA
Digital Input-Logic High		1.4			V
Digital Input-Logic Low				0.4	V
Digital Input Current				1	µA

## AC ELECTRICAL CHARACTERISTICS

(MAX2659 EV kit; V<sub>CC</sub> = 1.6V to 3.3V, T<sub>A</sub> = -40°C to +85°C, f<sub>RFIN</sub> = 1575.42MHz. Typical values are at V<sub>CC</sub> = 2.85V and T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
RF Frequency	L1 band		1575.42		MHz
Power Gain	V <sub>CC</sub> = 2.85V	17	20.5		dB
	V <sub>CC</sub> = 1.6V	16.5	20.5		
Noise Figure	(Note 2)		0.8		dB
3rd-Order Input Intercept Point	(Note 3)		-5		dBm
Input 1dB Compression point	(Note 4)		-12		dBm
Input Return Loss	(Note 2)	10	15		dB
Output Return Loss	(Note 2)	10	25		dB
Reverse Isolation	(Note 2)		32		dB

**Note 1:** Min and Max limits guaranteed by test at T<sub>A</sub> = +25°C and guaranteed by design and characterization at T<sub>A</sub> = -40°C and T<sub>A</sub> = +85°C.

**Note 2:** Guaranteed by design and characterization.

**Note 3:** Measured with the two tones located at 5MHz and 10MHz offset from the center of the GPS band with -40dBm/tone.

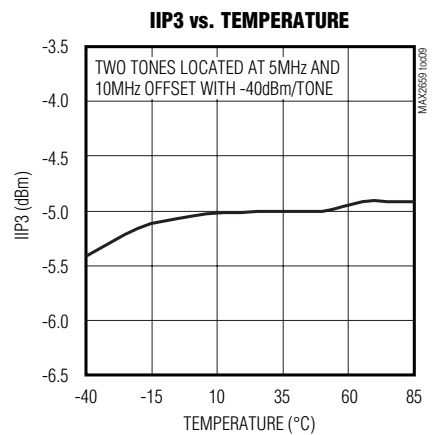
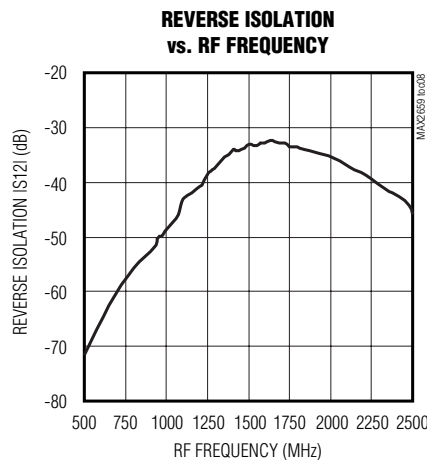
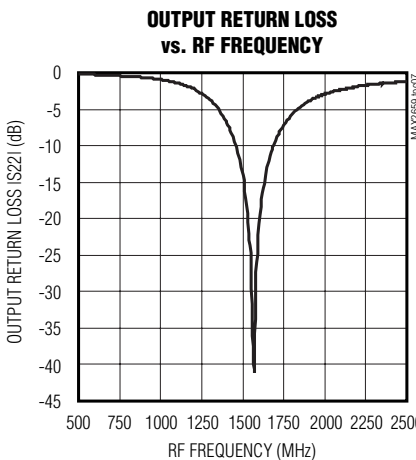
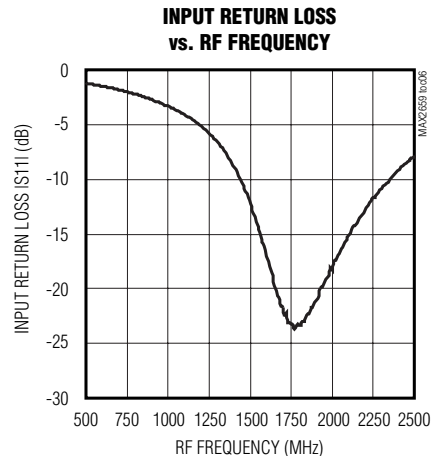
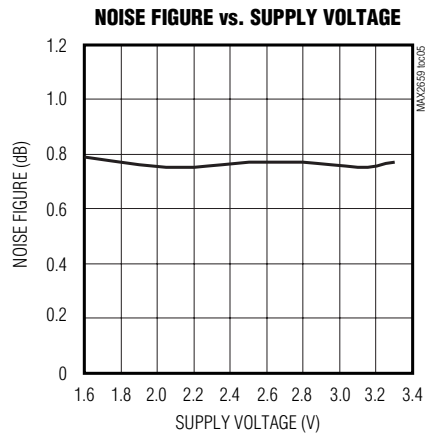
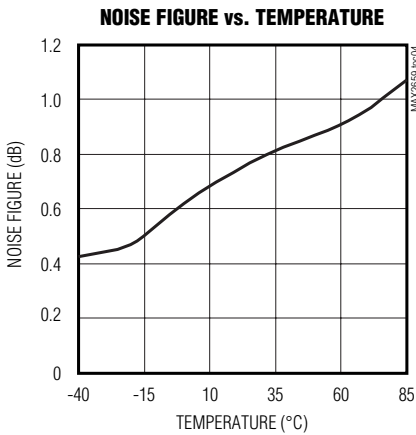
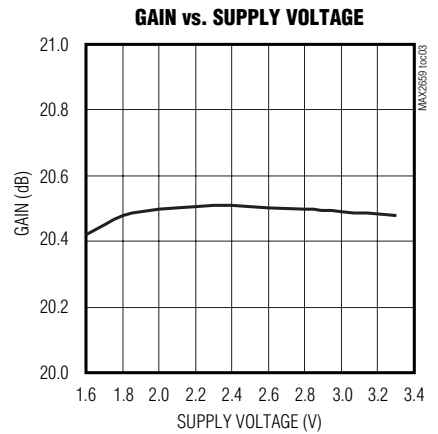
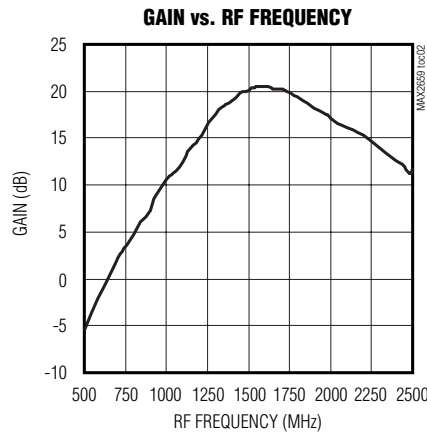
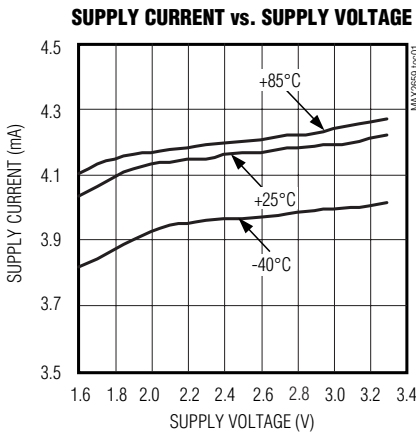
**Note 4:** Measured with a tone located at 5MHz offset from the center of the GPS band.

# GPS/GNSS Low-Noise Amplifier

MAX2659

## Typical Operating Characteristics

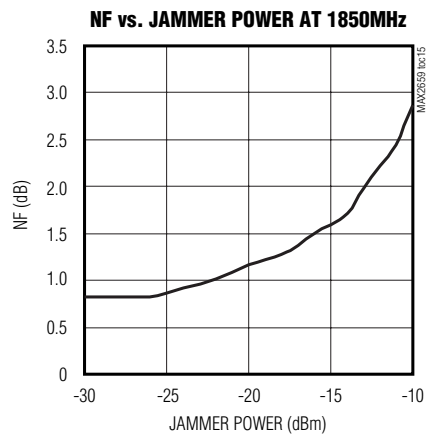
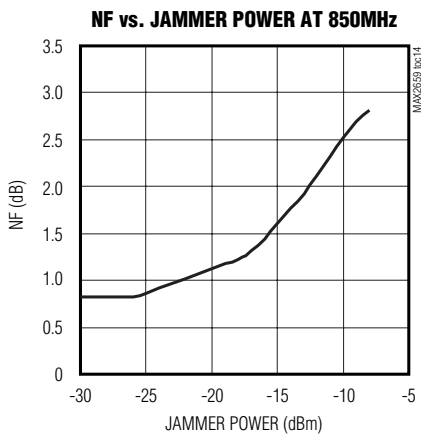
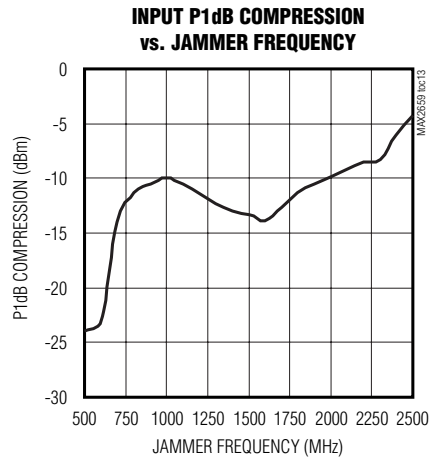
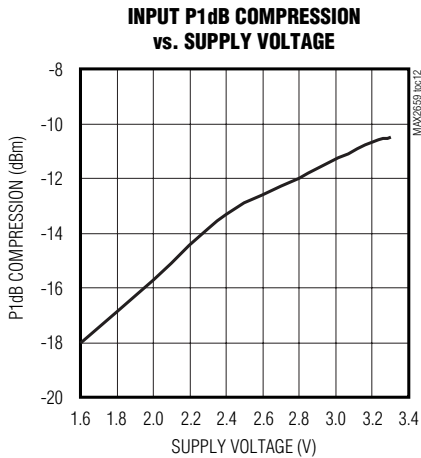
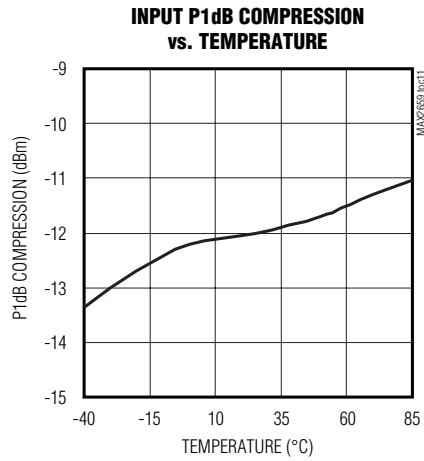
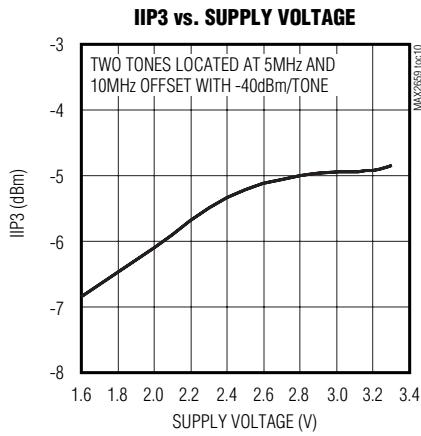
(MAX2659 EV kit; Typical values are at  $V_{CC} = 2.85V$ ,  $T_A = +25^\circ C$ , and  $f_{RFIN} = 1575.42MHz$ , unless otherwise noted.)



# GPS/GNSS Low-Noise Amplifier

## Typical Operating Characteristics (continued)

(MAX2659 EV kit; Typical values are at  $V_{CC} = 2.85V$ ,  $T_A = +25^\circ C$ , and  $f_{RFIN} = 1575.42MHz$ , unless otherwise noted.)



# GPS/GNSS Low-Noise Amplifier

MAX2659

## Pin Description

PIN	NAME	FUNCTION
1, 2	GND	Ground. Connect to the PCB ground plane.
3	RFIN	RF Input. Requires a DC-blocking capacitor and external matching components.
4	VCC	Supply Voltage. Bypass to ground with a 33nF capacitor as close as possible to the IC.
5	SHDN	Shutdown Input. A logic-low disables the device.
6	RFOUT	RF Output. RFOUT is internally matched to 50Ω and incorporates an internal DC-blocking capacitor.

## Detailed Description

The MAX2659 is an LNA designed for GPS L1, GALILEO, and GLONASS applications. The device features a power-shutdown control mode to eliminate the need for an external supply switch. The device achieves a 20.5dB gain and an ultra-low-noise figure of 0.8dB. The MAX2659 consumes approximately 4.1mA while providing a  $IP_{1dB}$  of -12dBm and an IIP3 of -5dBm.

### Input and Output Matching

The MAX2659 requires an off-chip input matching. Only a 6.8nH inductor in series with a DC-blocking capacitor is needed to form the input matching circuit. The *Typical Application Circuit* diagram shows the recommended input-matching network. These values are optimized for the best simultaneous gain, noise figure, and return loss performance. Table 1 lists typical device S11 values. The MAX2659 integrates an on-chip output matching to 50Ω at the output, eliminating the need for external matching components.

**Table 1. Typical S11 Values**

FREQUENCY (MHz)	REAL S11	IMAGINARY S11
1000	-0.58	-j0.52
1100	-0.68	-j0.356
1200	-0.74	-j0.16
1300	-0.74	j0.036
1400	-0.676	j0.22
1500	-0.56	j0.36
1575	-0.47	j0.415
1600	-0.44	j0.43
1700	-0.36	j0.467
1800	-0.3	j0.51
1900	-0.228	j0.567
2000	-0.14	j0.622

## Shutdown

The MAX2659 includes a shutdown feature to turn off the entire chip. Apply a logic high to SHDN pin to place the part in the active mode and a logic low to place the part in the shutdown mode.

## Applications Information

A properly designed PC board (PCB) is essential to any RF microwave circuit. Use controlled-impedance lines on all high-frequency inputs and outputs. Bypass VCC with decoupling capacitors located close to the device. For long VCC lines, it may be necessary to add decoupling capacitors. Locate these additional capacitors further away from the device package. Proper grounding of the GND pins is essential. If the PCB uses a top-side RF ground, connect it directly to the GND pins. For a board where the ground is not on the component layer, connect the GND pins to the board with multiple vias close to the package.

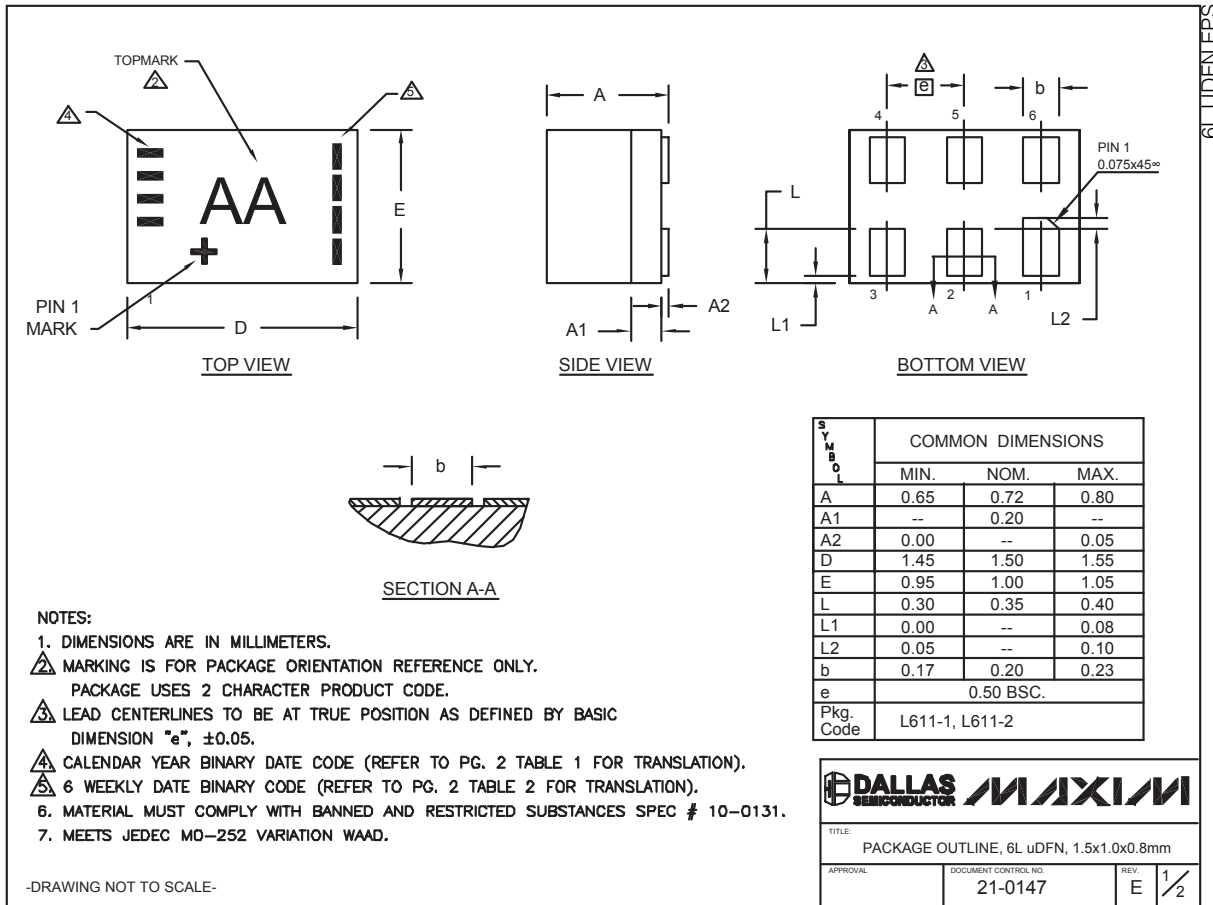
## Chip Information

PROCESS: SiGe BiCMOS

# GPS/GNSS Low-Noise Amplifier

## Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)



6LUDFNLEPS

**DALLAS SEMICONDUCTOR** **MAXIM**

TITLE: PACKAGE OUTLINE, 6L uDFN, 1.5x1.0x0.8mm

APPROVAL	DOCUMENT CONTROL NO. 21-0147	REV. E	1/2
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# GPS/GNSS Low-Noise Amplifier

MAX2659

## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)

**TABLE 1** Translation Table for Calendar Year Code

Calendar Year	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
	□	□	□	■	□	□	■	□	■	■
	□	□	■	□	□	■	□	■	□	□
	□	■	□	□	■	□	□	■	■	■
	■	□	□	□	■	■	■	□	□	□

Legend: ■ Marked with bar □ Blank space - no bar required

**TABLE 2** Translation Table for Payweek Binary Coding

Payweek	06-11	12-17	18-23	24-29	30-35	36-41	42-47	48-51	52-05
	□	□	□	■	□	□	■	□	■
	□	□	■	□	□	■	□	■	□
	□	■	□	□	■	□	□	■	■
	■	□	□	□	■	■	■	□	□

Legend: ■ Marked with bar □ Blank space - no bar required

TITLE: PACKAGE OUTLINE, 6L uDFN, 1.5x1.0x0.8mm	
APPROVAL:	DOCUMENT CONTROL NO. 21-0147
REV. E	2/2

-DRAWING NOT TO SCALE-

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